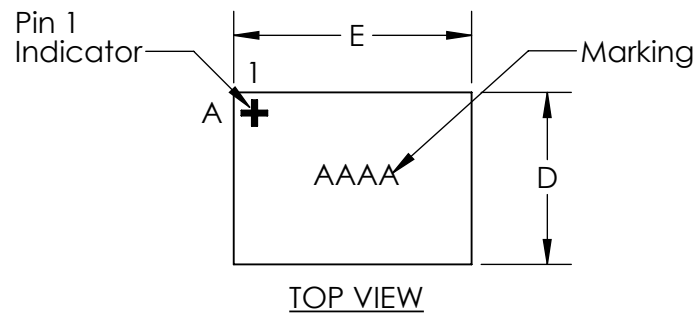
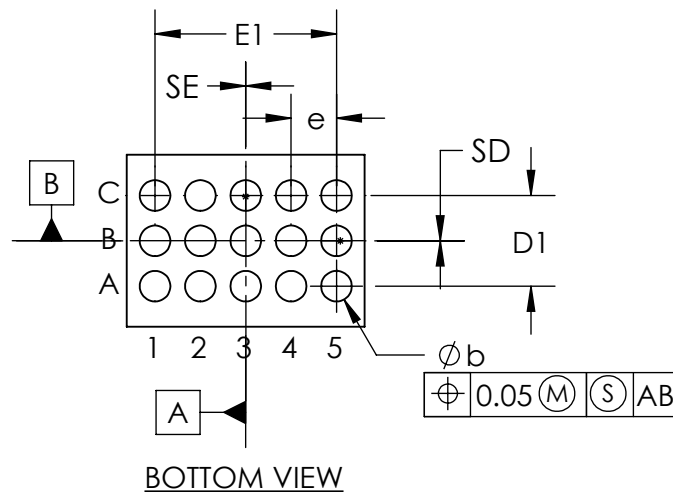


| COMMON DIMENSIONS          |              |
|----------------------------|--------------|
| A                          | 0.50 MAX     |
| A1                         | 0.19 ±0.03   |
| A2                         | 0.28 REF     |
| A3                         | See Note 8   |
| b                          | ∅0.27 ±0.03  |
| D                          | 1.518 ±0.025 |
| E                          | 2.098 ±0.025 |
| D1                         | 0.80 BASIC   |
| E1                         | 1.60 BASIC   |
| e                          | 0.40 BASIC   |
| SD                         | 0.00 BASIC   |
| SE                         | 0.00 BASIC   |
| DEPOPULATED BUMPS:<br>NONE |              |



#### NOTES:

1. Terminal pitch is defined by terminal center to center value.
2. Outer dimension is defined by center lines between scribe lines.
3. All dimensions in millimeter.
4. Marking shown is for package orientation reference only.
5. Tolerance is ± 0.02 unless specified otherwise.
6. All dimensions apply to PbFree (+) package codes only.
7. Front - side finish can be either Black or Clear.
8. 0.04 for 8"Wafer and 0.025 for 12"Wafer



|                                                                      |                                   |           |     |
|----------------------------------------------------------------------|-----------------------------------|-----------|-----|
| TITLE<br>PACKAGE OUTLINE 15 BUMPS<br>WLP PKG. 0.4 mm PITCH, N151A2+1 |                                   |           |     |
| APPROVAL                                                             | DOCUMENT CONTROL NO.<br>21-100295 | REV.<br>B | 1/1 |